#### 506758824 07/09/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT6805641

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YUUSUKE OOTA	07/06/2021
ATSUSHI NOHARA	07/09/2021
DAISUKE NAKAJIMA	07/06/2021

## **RECEIVING PARTY DATA**

Name:	SEKISUI CHEMICAL CO., LTD.
Street Address:	4-4, NISHITEMMA 2-CHOME, KITA-KU, OSAKA-SHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	5308565

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17421125

## CORRESPONDENCE DATA

Fax Number: (202)721-8250

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email: WLP@WENDEROTH.COM

WENDEROTH, LIND & PONACK L.L.P **Correspondent Name:** Address Line 1: 1025 CONNECTICUT AVENUE NW

Address Line 2: SUITE 500

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ATTORNEY DOCKET NUMBER:	2020-2937A
NAME OF SUBMITTER:	KELLY GREENE
SIGNATURE:	/Kelly Greene/
DATE SIGNED:	07/09/2021

#### **Total Attachments: 4**

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> **PATENT** REEL: 056807 FRAME: 0861 506758824

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PATENT REEL: 056807 FRAME: 0862 Wenderoth, Lind & Ponack, LLP Attorney Docket No.: 2020-2937A

COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN APPLICATION	
Title of Invention	INTERLAYER FILM FOR LAMINATED GLASS, AND LAMINATED GLASS
***************************************	DECLARATION
As a below na	med inventor, I hereby declare that:
This declaration is directed to:	The attached application, or
	United States application or PCT international application
	number PCT/JP2020/000350 filed on January 8, 2020.
The above-ide	ntified application was made or authorized to be made by me.
I believe that I	am the original inventor or an original joint inventor of a claimed invention in the application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
Note to Inventor: 37 C.F.R. § 1.63(c) states: "A person may not execute an oath or declaration for an application unless that person has reviewed and understands the contents of the application, including the claims, and is aware of the duty to disclose to the Office all information known to the person to be material to patentability as defined in § 1.56."	
** : * * * * :	ASSIGNMENT
In consideration	on of the good and valuable consideration paid, I hereby sell and assign to
SEKISUI CH (Name of A	EMICAL CO., LTD. ssignee)
of <u>4-4, Nishit</u> (address of	emma 2-chome, Kita-ku, Osaka-shi, Osaka 5308565, Japan Assignee)
	esignated as the Assignee) my entire right, title and interest for the United States as defined in 35 USC evention set forth in the above-identified application.
I agree to execute all papers necessary in connection with this application for patent in the USPTO for the invention, and any continuation, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.	
I agree to execute all papers necessary in connection with any post-grant proceeding which may occur in connection with this application or continuation, divisional or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such post-grant proceeding.	
The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements, which includes the right to claim priority and the right to be granted a patent in any PCT Contracting State.	

PATENT REEL: 056807 FRAME: 0863

I agree to perform all affirmative acts which may be necessary to Assignee.	obtain a grant of a valid United States patent to the	
I hereby authorize and request the USPTO to issue any and all Letters Patents of the United States resulting from the application or any continuation, divisional or reissue applications thereof to the Assignee, as Assignee of my entire interest, and covenant that I have not executed, and will not execute, any agreement in conflict herewith.		
First Inventor (Legal Name): Yuusuke OOTA		
Signature: Yuusuce DoTa	Date: 7/6/2021	
Second Inventor (Legal Name): <u>Atsushi NOHARA</u>		
Signature;	Date:	
Third Inventor (Legal Name): Daisuke NAKAJIMA		
Signature:	Date:	

I agree to perform all affirmative acts which may be necessary to Assignee.	obtain a grant of a valid United States patent to the
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First Inventor (Legal Name): Yuusuke OOTA	
Signature:	Date:
Second Inventor (Legal Name): <u>Atsushi NOHARA</u> Signature: <u>Utsushi Nehalla</u>	Date: 7/9/202 \
Third Inventor (Legal Name): <u>Daisuke NAKAJIMA</u>	
Signature:	Date:

I agree to perform all affirmative acts which may be necessary to Assignee.	obtain a grant of a valid United States patent to the
I hereby authorize and request the USPTO to issue any and all Letters Patents of the United States resulting from the application or any continuation, divisional or reissue applications thereof to the Assignee, as Assignee of my entire interest, and covenant that I have not executed, and will not execute, any agreement in conflict herewith.	
First Inventor (Legal Name): Yuusuke OOTA	
Signature:	Date:
Second Inventor (Legal Name): <u>Atsushi NOHARA</u>	
Signature:	Date:
Third Inventor (Legal Name): <u>Daisuke NAKAIIMA</u> Signature: <u>Pal'suke Nakajima</u>	Date: 6th Tuly 2021